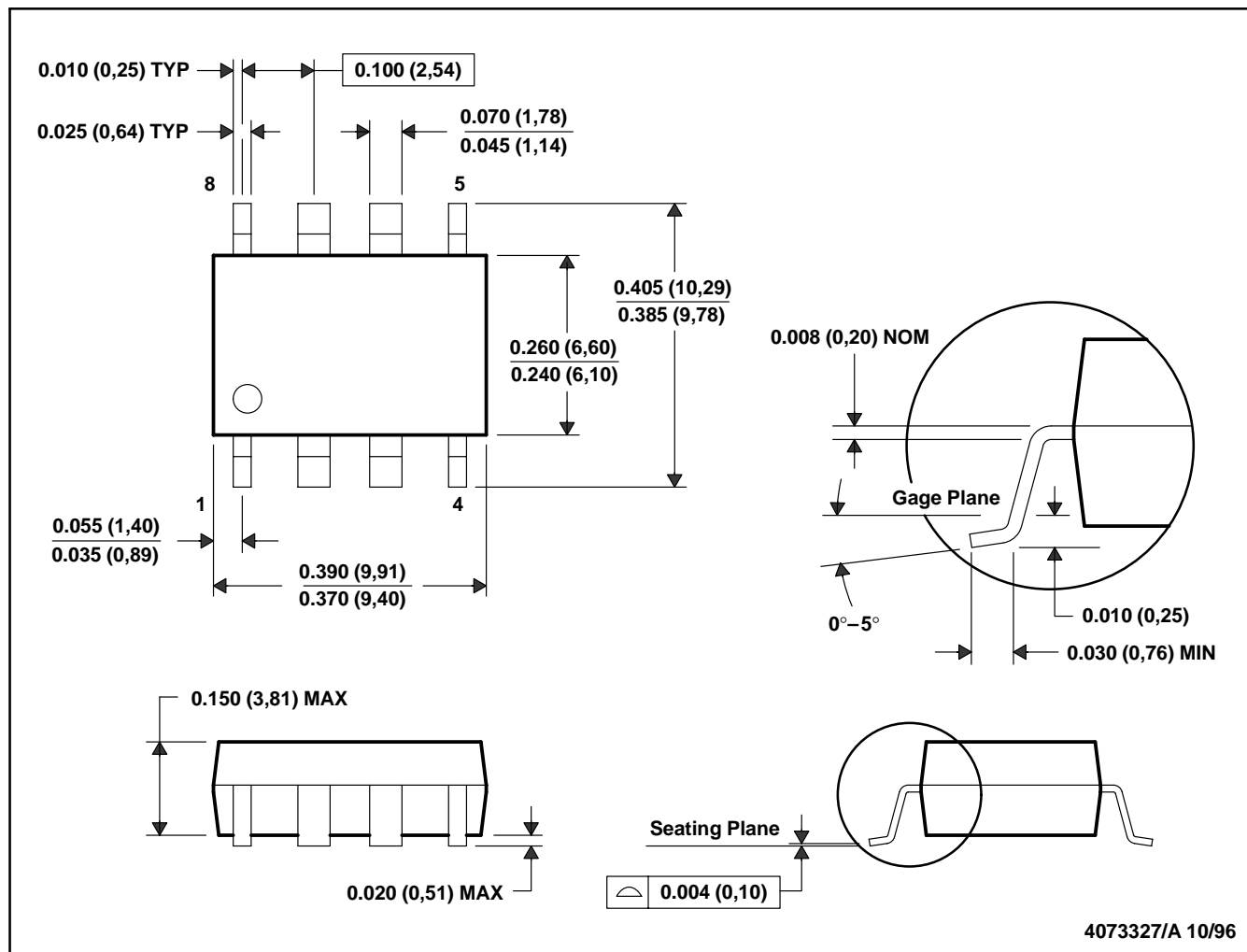


DCS (R-PDSO-G8)

PLASTIC DUAL SMALL-OUTLINE OPTO COUPLER



- NOTES: A. All linear dimensions are in inches(millimeters).
 B. This drawing is subject to change without notice.

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